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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







GHz Noise Suppression Chip Ferrite Bead **BLM18EG** □ □ □ **N1**□

Reference Specification

1. Scope

This reference specification applies to Chip Ferrite Bead BLM18EG_ N Series.

2. Part Numbering

(ex.)	_BL_	M	18	EG	601	S	N	_1_	D	
. ,	(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)	
	(4) D _{**}	عاديمه ال	\ (O)T		(2) Dim or	00100/1	14/1	(4) Ch	arastaristics	(E)T

 $(1) Product \ ID \quad (2) Type \quad (3) Dimension (L \times W) \quad (4) Characteristics \quad (5) Typical \ Impedance \ at \ 100 MHz$

(6)Performance (7)Category (8)Numbers of Circuit (9)Packaging(D:Taping / B:Bulk)

3. Rating

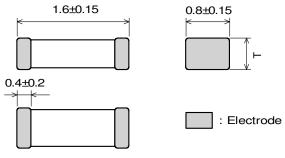
			dance (Ω)		DC Resistance			
Customer	MURATA	(Under Standar	d Testing Co	ondition)	Rated			
Part Number	Part Number		at 1GHz		Current		Values	Remark
		at 100MHz		Typical	(mA)	Values	After Testing	
	BLM18EG101TN1D						Ŭ	
	BLM18EG101TN1B	100±25%	80 min.	140	2000	0.045	0.07	
	BLM18EG221TN1D	000.050/	100 :	000	1000	0.15	0.04	For
	BLM18EG221TN1B	220±25%	180 min.	300	1000	0.15	0.21	general
	BLM18EG331TN1D	330± 25%	200 min	450	500	0.21	0.20	use
	BLM18EG331TN1B	330± 25%	280 min.	450	500	0.21	0.30	(Thin type)
	BLM18EG391TN1D	390±25%	320 min.	520	500	0.30	0.40	
	BLM18EG391TN1B	39012376	320 IIIII.	320	300	0.30	0.40	
	BLM18EG121SN1D	120±25%	90 min.	145	2000	0.04	0.06	
	BLM18EG121SN1B	12012576	90 mm.	140	2000	0.04	0.00	
	BLM18EG221SN1D	220±25%	160 min.	260	2000	0.05	0.08	F
	BLM18EG221SN1B	22012378	100 111111.	200	2000	0.03	0.00	For general
	BLM18EG471SN1D	470± 25%	340 min.	550	500	0.21	0.30	use
	BLM18EG471SN1B	4/U± 25/0	0 1 0 IIIII.	550	300	0.21	0.00	
	BLM18EG601SN1D	600±25%	450 min.	700	500	0.35	0.45	
	BLM18EG601SN1B	00012076	- 50 IIIII.	, 00	500	0.00	0.40	

[•] Operating Temperature : -55°C to +125°C

As for BLM18EG type,Rated Current is derated as right figure depending on the operating temperature.

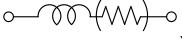
Operating Temperature (°C)

4. Style and Dimensions



Part Number	Dimension(T)
BLM18EG***TN1	0.5±0.15
BLM18EG***SN1	0.8±0.15

Equivalent Circuit



Resistance element becomes dominant at high frequencies.

■ Unit Mass (Typical value)

BLM18EG***TN1: 0.004g BLM18EG***SN1: 0.005g

(in mm)

Storage Temperature : -55°C to +125°C

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Reference Only

5. Marking

No marking.

6. Standard Testing Conditions

< Unless otherwise specified >

Temperature : Ordinary Temp. (15 °C to 35 °C) Humidity : Ordinary Humidity (25%(RH) to 85%(RH)) < In case of doubt >

Temperature : 20°C±2 °C Humidity : 60%(RH) to 70%(RH)

Atmospheric pressure: 86kPa to 106kPa

7. Specifications

7-1. Electrical Performance

No.	Item	Specification	Test Method
7-1-1	Impedance	Meet item 3.	Measuring Frequency: 100MHz±1MHz, 1GHz±1MHz Measuring Equipment: Agilent4291A or the equivalent Test Fixture: Agilent16192A or the equivalent
7-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter

7-2. Mechanical Performance

No.	echanical Perforn	Specification	Test Method			
	Appearance and Dimensions	Meet item 4.	Visual Inspection and measured with Slide Calipers.			
7-2-2	Bonding Strength	Meet Table 1. Table 1	It shall be soldered on the substrate. Applying Force(F): 10N Applying Time: 5s±1s Applying Direction: Parallel to the substrate.			
		Appearance No damage	Side view			
		Impedance Change Within ±30% (at 100MHz)	R0.5			
		DC Resistance Meet item 3.	Substrate			
7-2-3	Bending Strength		It shall be soldered on the substrate. Substrate: Glass-epoxy 100mm×40mm×1.6mm Deflection: 2.0mm Speed of Applying Force: 0.5mm/s Keeping Time: 30s Pressure jig R340 F Deflection			
7-2-4	Vibration		It shall be soldered on the substrate. Oscillation Frequency: 10Hz to 2000Hz to 10Hz			
			for 20 min Total Amplitude 1.5mm or Acceleration 196m/s ² whichever is smaller Testing Time: A period of 2 hours in each of 3 mutually perpendicular directions. (Total 6 h)			
7-2-5	Resistance to Soldering Heat		Pre-Heating: 150°C±10°C, 60s ~ 90s Solder: Sn-3.0Ag-0.5Cu Solder Temperature: 270°C±5°C Immersion Time: 10s±0.5s Immersion and emersion rates: 25mm/s Then measured after exposure in the room condition for 48h±4h.			
7-2-6	Drop	Products shall be no failure after tested.	It shall be dropped on concrete or steel board. Method : free fall Height : 1m The number of times : 10 times			

No.	Item	Specification	Test Method
7-2-7	Solderability	The electrodes shall be at least 95% covered with new solder coating.	Flux: Ethanol solution of rosin,25(wt)% Pre-Heating: 150°C±10°C, 60s ~ 90s Solder: Sn-3.0Ag-0.5Cu Solder Temperature: 240°C±5°C Immersion Time: 3s±1s Immersion and emersion rates: 25mm/s

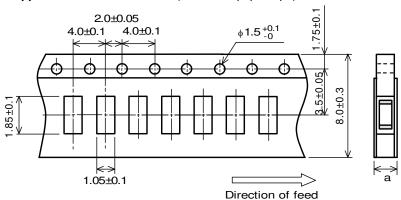
7-3. Environmental Performance

It shall be soldered on the substrate.

No.	Item	Specification	Test Method
7-3-1	Temperature Cycle	Meet Table 1.	1 cycle: 1 step: -55 °C (+0 °C, -3 °C) / 30min±3min 2 step: Ordinary temp. / 3min max. 3 step: +125 °C (+3 °C, -0 °C) / 30min±3min 4 step: Ordinary temp. / 3min max. Total of 100 cycles Then measured after exposure in the room condition for 48h±4h.
7-3-2	Humidity		Temperature: 85°C±2°C Humidity: 80%(RH) to 85%(RH) Time: 1000h (+48h, -0h) Then measured after exposure in the room condition for 48h±4h.
7-3-3	Heat Life		Temperature: 125°C±3°C Applying Current: Rated Current Time: 1000h (+48h, -0h) Then measured after exposure in the room condition for 48h±4h.
7-3-4	Cold Resistance		Temperature: -55±2°C Time: 1000h (+48h, -0h) Then measured after exposure in the room condition for 48h±4h.

8. Specification of Packaging

8-1. Appearance and Dimensions (8mm-wide paper tape)



Part Number	Dimension (a)
BLM18EG***TN1	0.85 max.
BLM18EG***SN1	1.1 max.
	(in mm)

(1) Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide, 4mm-pitch continuously and sealed by top tape and bottom tape.

(2) Sprocket hole

The sprocket holes are to the right as the tape is pulled toward the user.

(3) Spliced point

The base tape and top tape have no spliced point

(4) Cavity

There shall not be burr in the cavity.

(5) Missing components number

Missing components number within 0.1% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

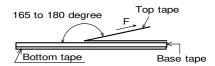
8-2. Tape Strength

(1)Pull Strength

Top tape	5N min
Bottom tape	OIN MIN.

(2)Peeling off force of Top tape

0.1N to 0.6N (Minimum value is typical.)
*Speed of Peeling off:300mm/min



8-3. Taping Condition

(1) Standard quantity per reel

Quantity per 180mm reel: 4000 pcs. / reel

- (2) There shall be leader-tape (top tape and empty tape) and trailer- tape(empty tape) as follows.
- (3) On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.
- (4) Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number (*1), RoHS marking (*2), Quantity, etc)

*1) « Expression of Inspection No. »

$$\frac{\Box \ \Box}{(1)} \quad \frac{OOOO}{(2)} \quad \frac{\times \times \times}{(3)}$$

(1) Factory Code

(2) Date First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O, N, D

Third, Fourth digit: Day

(3) Serial No.

*2) « Expression of RoHS marking »

ROHS
$$-\underline{Y}$$
 (\triangle) (1) (2)

- (1) RoHS regulation conformity parts.
- (2) MURATA classification number

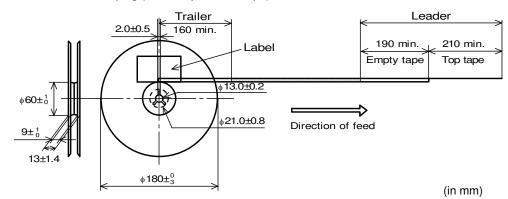
(5) Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

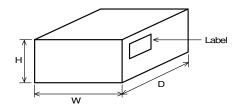
(Customer name, Purchasing Order Number, Customer Part Number, MURATA part number,

RoHS marking (*2), Quantity, etc)

(6) Dimensions of reel and taping (leader-tape, trailer-tape)



8-4. Specification of Outer Case



Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case
W	D	Н	(Reel)
186	186	93	5

^{*} Above Outer Case size is typical. It depends on a quantity of an order.



9. / Caution

9-1.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

9-2. Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1)Aircraft equipment (2)Aerospace equipment (3)Undersea equipment
- (4)Power plant control equipment (5)Medical equipment (6)Disaster prevention / crime prevention equipment
- (7)Traffic signal equipment (8)Transportation equipment (vehicles, trains, ships, etc.)
- (9)Applications of similar complexity and /or reliability requirements to the applications listed in the above

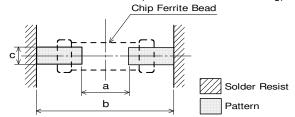
10. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

10-1. Land pattern designing

• Standard land dimensions (Flow and Reflow soldering)



Soldering	а	b	С	
Flow	0.7	2.2 to 2.6	0.7	
Reflow	0.7	1.8 to 2.0	0.7	
			(in mm)	

10-2. Soldering Conditions

Products can be applied to reflow and flow soldering.

(1) Flux, Solder

Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.) Do not use water-soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder
	Standard thickness of solder paste : 100 μm to 200 μm

(2) Soldering conditions

• Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

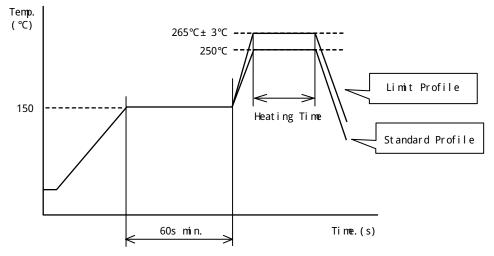
• Standard soldering profile and the limit soldering profile is as follows.

The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

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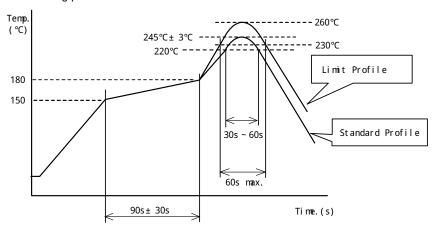
Reference Only

□ Flow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150°C, 60s min.	
Heating	250°C, 4s~6s	265°C±3°C, 5s max.
Cycle of flow	2 times	2 times

□ Reflow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150°C~180°C, 90s±30s	
Heating	above 220°C, 30s~60s	above 230°C, 60s max.
Peak temperature	245°C±3°C	260°C, 10s
Cycle of reflow	2 times	2 times

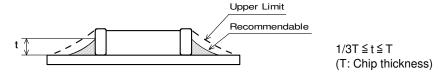
10-3. Reworking with soldering iron

- Pre-heating: 150°C, 1 min
- Tip temperature: 350°C max.Soldering time: 3 (+1, -0) s
- Soldering iron output: 80W max.
- Tip diameter: φ 3mm max.
- Times : 2times max.

Note: Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

10-4. Solder Volume

Solder shall be used not to be exceed as shown below.

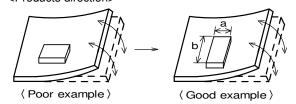


Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

10-5. Attention regarding P.C.B. bending

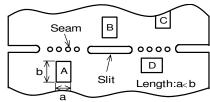
The following shall be considered when designing and laying out P.C.B.'s.

P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage.
 Products direction>



Products shall be located in the sideways direction (Length: a<b) to the mechanical stress.

(2)Products location on P.C.B. separation.



Products (A, B, C, D) shall be located carefully so that products are not subject to the mechanical stress due to warping the board. Because they may be subjected the mechanical stress in order of A>C>B \cong D.

10-6. Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

10-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere (acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc.)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

10-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

10-9. Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1)Cleaning temperature shall be limited to 60°C max. (40°C max. for IPA)
- (2)Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.

Power:20W/ℓ max. Frequency:28kHz to 40kHz Time:5 min max.

- (3)Cleaner
 - 1.Cleaner
 - •Isopropyl alcohol (IPA)
 - 2. Aqueous agent
 - •PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning.

In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

(5)Other cleaning

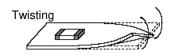
Please contact us.

10-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.





10-11. Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity : 15% to 85% relative humidity No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be stored under the airtight packaged condition.

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

11. 🗥 Note

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.